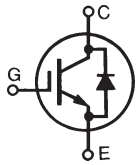
XPT™ 650V IGBT GenX3™ w/ Sonic Diode

IXYH40N65C3H1

V_{CES} = 650V
I_{C110} = 40A
$V_{CE(sat)}$ ≤ 2.35V
$t_{fi(typ)}$ = 52ns

Extreme Light Punch Through
IGBT for 20-60 kHz Switching



Symbol	Test Conditions	Maximum Ratings	
V_{CES}	T_J = 25°C to 175°C	650	V
V_{CGR}	T_J = 25°C to 175°C, R_{GE} = 1MΩ	650	V
V_{GES}	Continuous	±20	V
V_{GEM}	Transient	±30	V
I_{C25}	T_C = 25°C	80	A
I_{C110}	T_C = 110°C	40	A
I_{F110}	T_C = 110°C	40	A
I_{CM}	T_C = 25°C, 1ms	180	A
I_A	T_C = 25°C	20	A
E_{AS}	T_C = 25°C	300	mJ
SSOA (RBSOA)	V_{GE} = 15V, T_{VJ} = 150°C, R_G = 10Ω Clamped Inductive Load	I_{CM} = 80 $V_{CE} \leq V_{CES}$	A
t_{sc} (SCSOA)	V_{GE}= 15V, V_{CE} = 360V, T_J = 150°C R_G = 82Ω, Non Repetitive	5	μs
P_C	T_C = 25°C	300	W
T_J		-55 ... +175	°C
T_{JM}		175	°C
T_{stg}		-55 ... +175	°C
T_L	Maximum Lead Temperature for Soldering	300	°C
T_{SOLD}	1.6 mm (0.062in.) from Case for 10s	260	°C
M_d	Mounting Torque	1.13/10	Nm/lb.in
Weight		6	g

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
BV_{CES}	I_C = 250μA, V_{GE} = 0V	650			V
$V_{GE(th)}$	I_C = 250μA, V_{CE} = V_{GE}	3.5		6.0	V
I_{CES}	V_{CE} = V_{CES}, V_{GE} = 0V			50	μA
	T_J = 150°C			3	mA
I_{GES}	V_{CE} = 0V, V_{GE} = ±20V			±100	nA
$V_{CE(sat)}$	I_C = 40A, V_{GE} = 15V, Note 1		2.00	2.35	V
	T_J = 150°C		2.40		V

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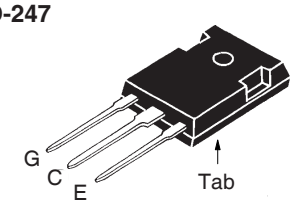

G = Gate C = Collector
E = Emitter Tab = Collector

Features

- Optimized for 20-60kHz Switching
- Square RBSOA
- Anti-Parallel Sonic Diode
- Avalanche Rated
- Short Circuit Capability
- International Standard Package

Advantages

- High Power Density
- Extremely Rugged
- Low Gate Drive Requirement

Applications

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts
- High Frequency Power Inverters

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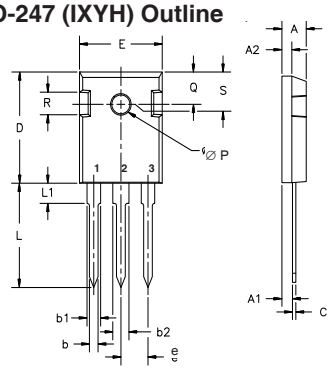
Symbol	Test Conditions (T_J = 25°C Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
g_{fs}	I_C = 40A, V_{CE} = 10V, Note 1	16	27		S
C_{ies}	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz		1980		pF
C_{oes}			215		pF
C_{res}			40		pF
$Q_{g(on)}$	I_C = 40A, V_{GE} = 15V, V_{CE} = 0.5 • V_{CES}		70		nC
Q_{ge}			14		nC
Q_{gc}			34		nC
$t_{d(on)}$	**Inductive load, T_J = 25°C**		26		ns
t_{ri}	I_C = 30A, V_{GE} = 15V		40		ns
E_{on}	V_{CE} = 400V, R_G = 10Ω		0.86		mJ
$t_{d(off)}$	Note 2		106		ns
t_{fi}			52		ns
E_{off}			0.40	0.75	mJ
$t_{d(on)}$	**Inductive load, T_J = 150°C**		25		ns
t_{ri}	I_C = 30A, V_{GE} = 15V		40		ns
E_{on}	V_{CE} = 400V, R_G = 10Ω		1.33		mJ
$t_{d(off)}$	Note 2		126		ns
t_{fi}			80		ns
E_{off}			0.46		mJ
R_{thJC}				0.50	°C/W
R_{thCS}			0.21		°C/W

TO-247 (IXYH) Outline



Terminals: 1 - Gate 2 - Collector
3 - Emitted

Dim.	Millimeter Min.	Max.	Inches Min.	Max.
A	4.7	5.3	.185	.209
A_1	2.2	2.54	.087	.102
A_2	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b_1	1.65	2.13	.065	.084
b_2	2.87	3.12	.113	.123
C	.4	.8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
e	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L1		4.50		.177
∅P	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15 BSC		242 BSC	

Reverse Sonic Diode (FRD)

Symbol	Test Conditions (T_J = 25°C Unless Otherwise Specified)		Characteristic Values Min.	Typ.	Max.	
V_F	I_F = 30A, V_{GE} = 0V, Note 1				2.5	V
		T_J = 150°C		2.15		V
I_{RM}	I_F = 30A, V_{GE} = 0V,	T_J = 150°C		32		A
t_{rr}	$-di_F/dt$ = 900A/μs, V_R = 300V	T_J = 150°C		78		ns
R_{thJC}					0.60	°C/W

Notes:

1. Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.
2. Switching times & energy losses may increase for higher V_{CE}(clamp), T_J or R_G.

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IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,860,072 4,881,106 4,931,844 5,017,508 5,034,796 5,049,961 5,063,307 5,187,117 5,237,481 5,381,025 5,486,715 6,162,665 6,259,123 B1 6,306,728 B1 6,404,065 B1 6,534,343 6,583,505 6,683,344 6,710,405 B2 6,710,463 6,727,585 6,759,692 6,771,478 B2 7,005,734 B2 7,063,975 B2 7,071,537 7,157,338B2

Fig. 1. Output Characteristics @ T_J = 25ºC

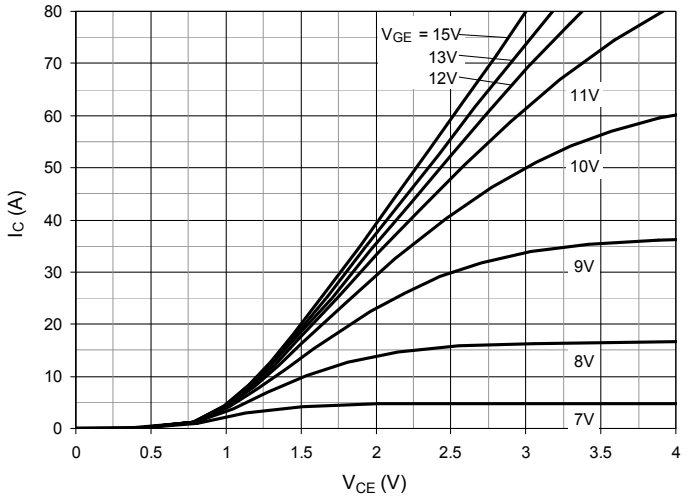

Fig. 2. Extended Output Characteristics @ T_J = 25ºC

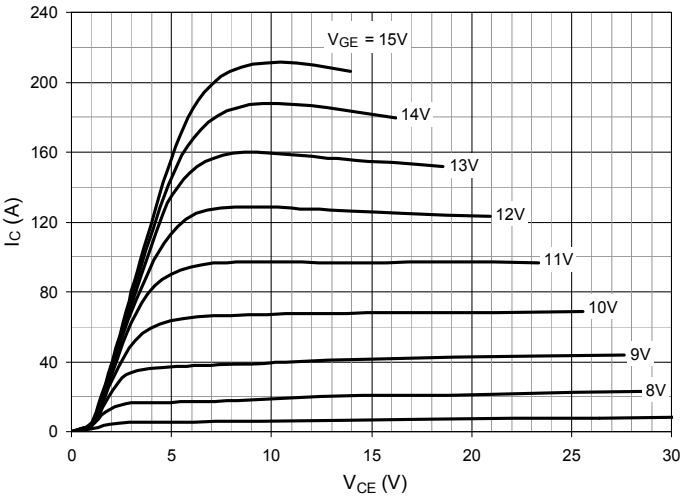

Fig. 3. Output Characteristics @ T_J = 150ºC

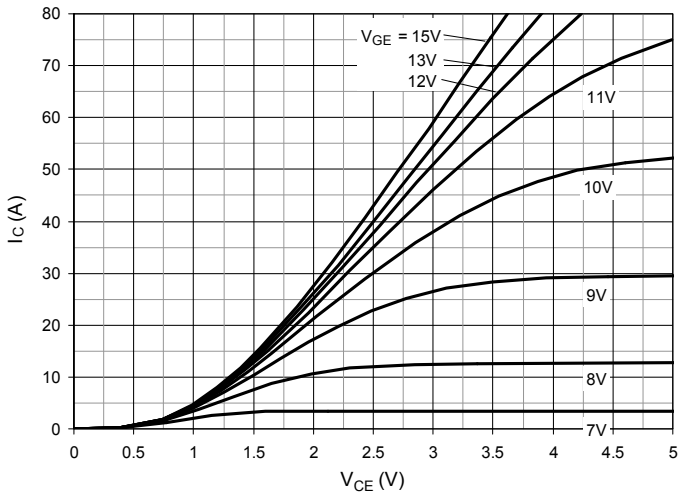

Fig. 4. Dependence of $V_{CE(sat)}$ on Junction Temperature

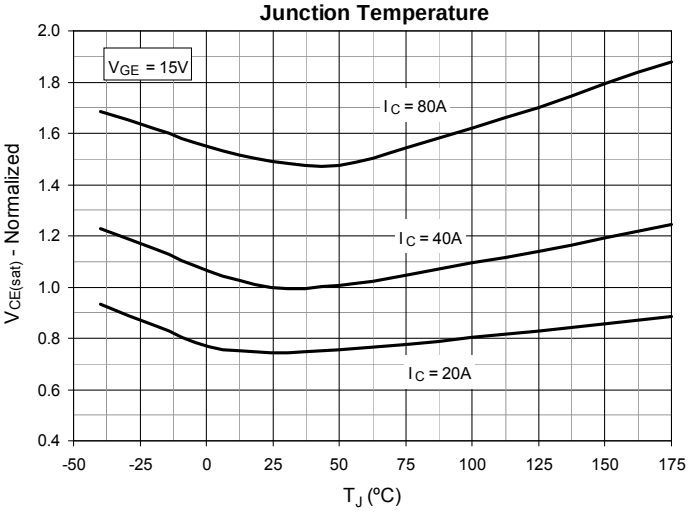

Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

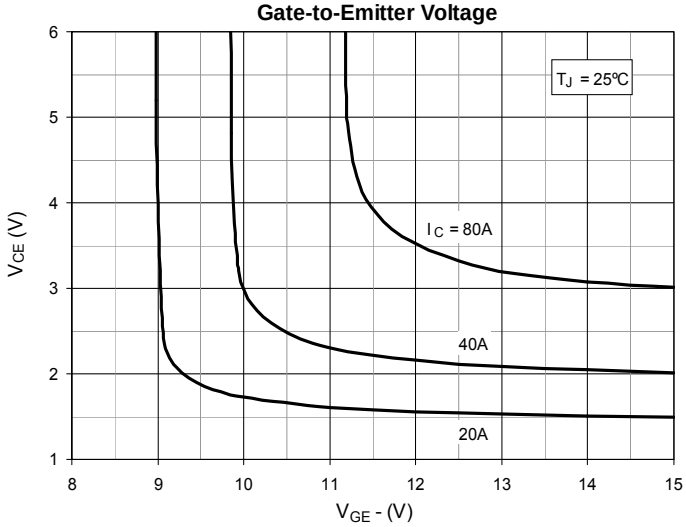

Fig. 6. Input Admittance

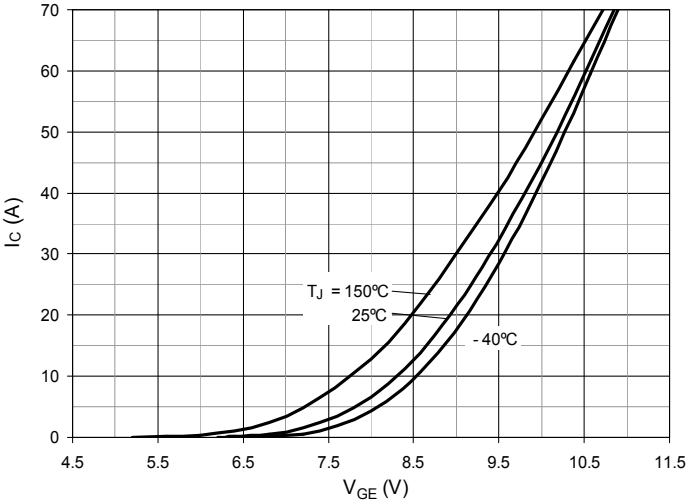

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Fig. 7. Transconductance

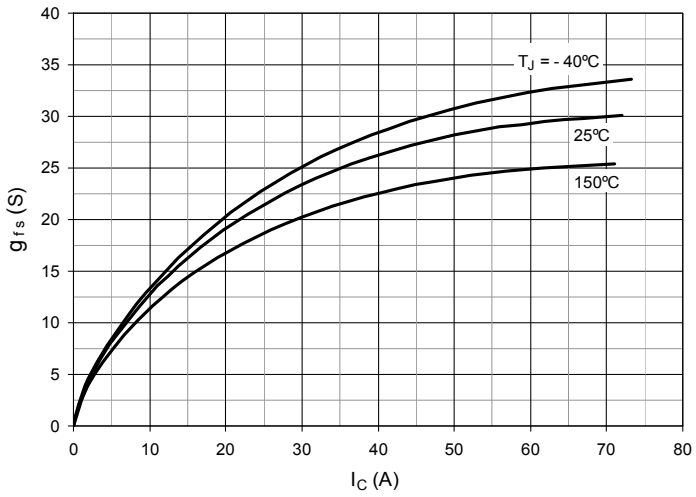

Fig. 8. Gate Charge

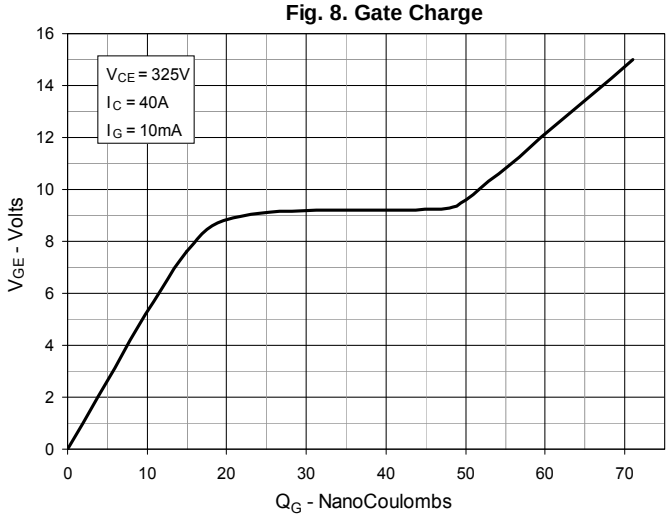

Fig. 9. Capacitance

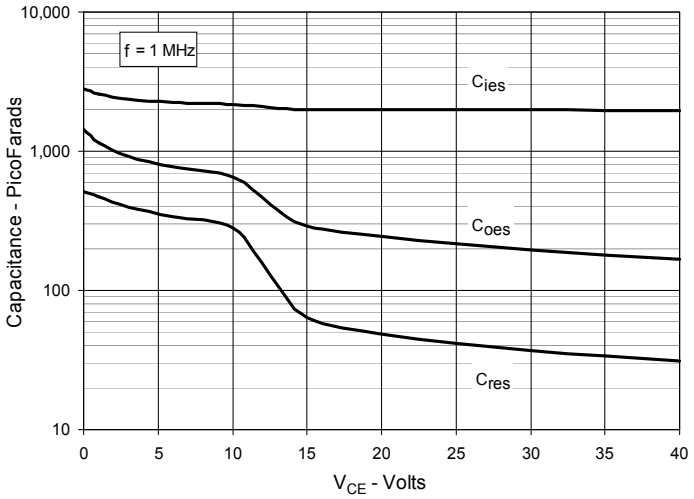

Fig. 10. Reverse-Bias Safe Operating Area

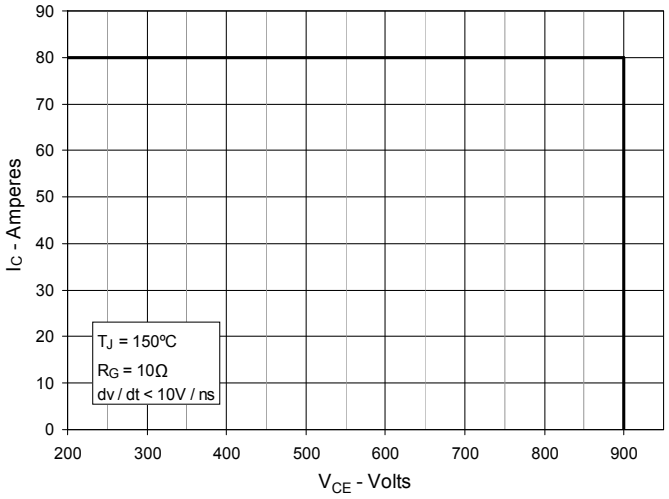

Fig. 11. Forward-Bias Safe Operating Area

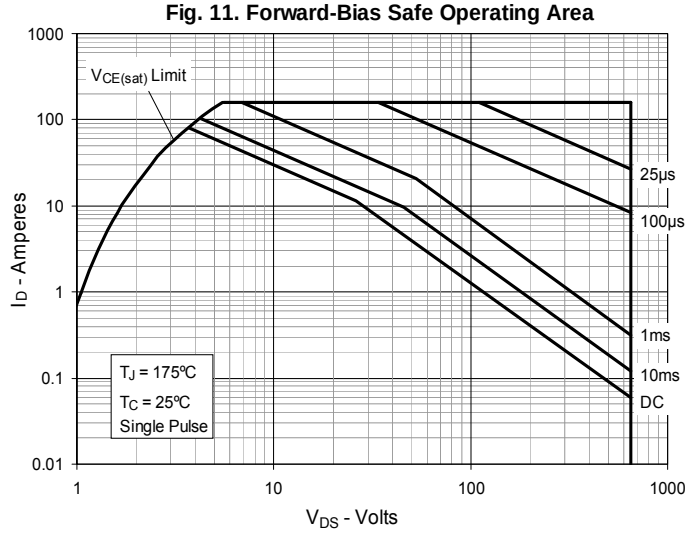

Fig. 12. Maximum Transient Thermal Impedance (IGBT)

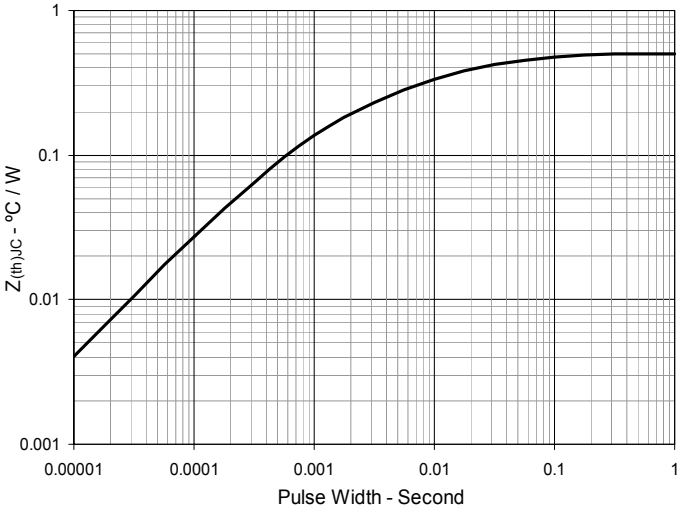

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Fig. 13. Inductive Switching Energy Loss vs. Gate Resistance

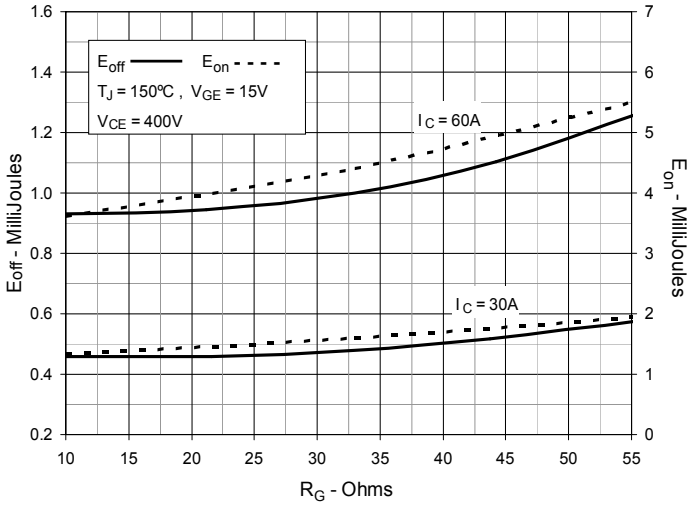

Fig. 14. Inductive Switching Energy Loss vs. Collector Current

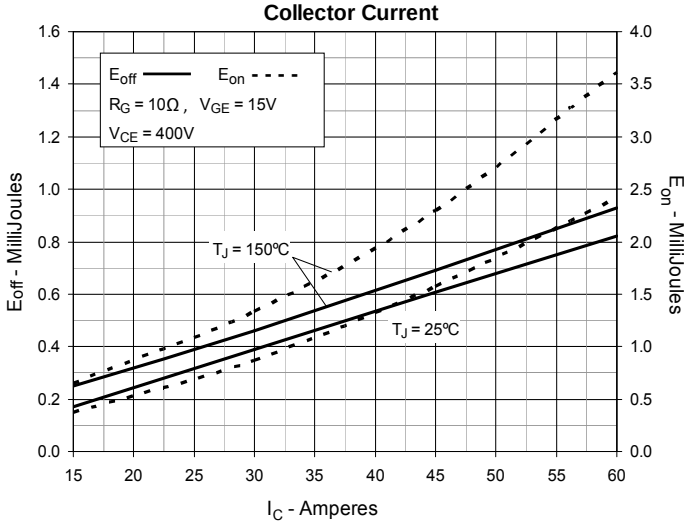

Fig. 15. Inductive Switching Energy Loss vs. Junction Temperature

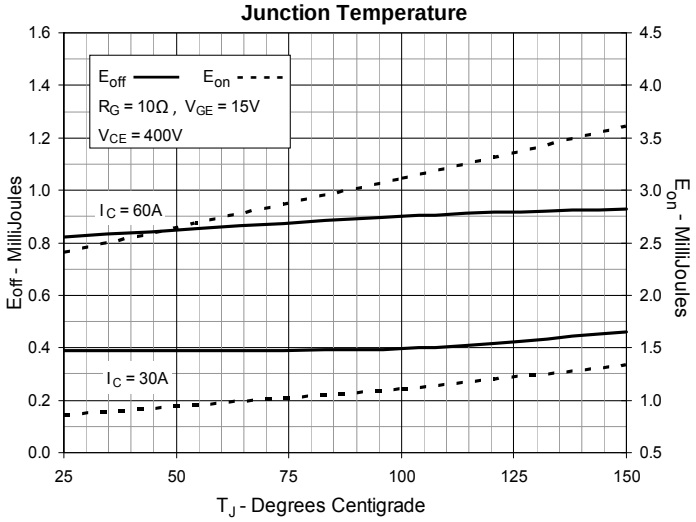

Fig. 16. Inductive Turn-off Switching Times vs. Gate Resistance

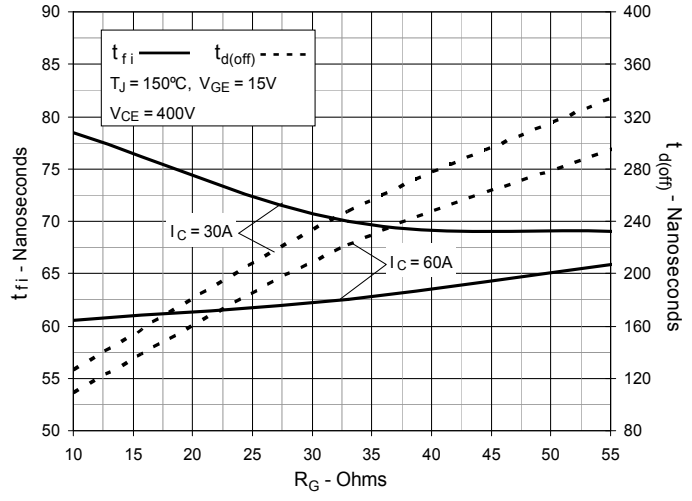

Fig. 17. Inductive Turn-off Switching Times vs. Collector Current

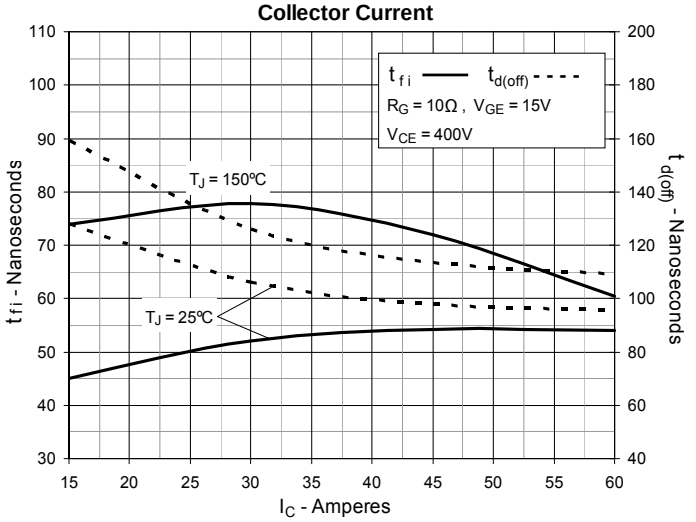

Fig. 18. Inductive Turn-off Switching Times vs. Junction Temperature

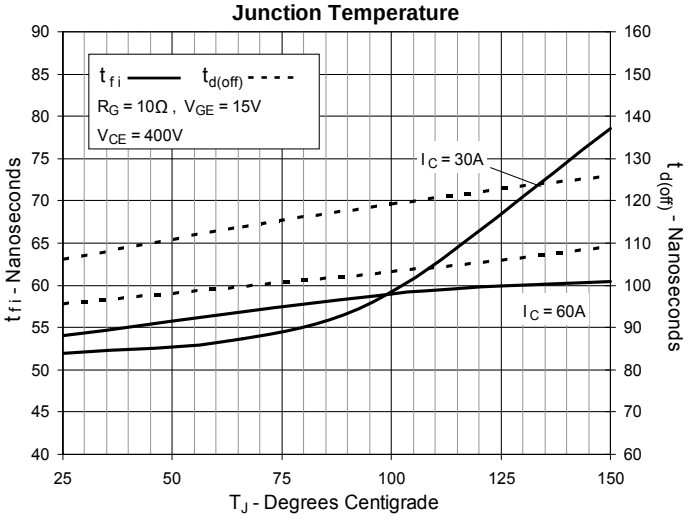

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Fig. 19. Inductive Turn-on Switching Times vs. Gate Resistance

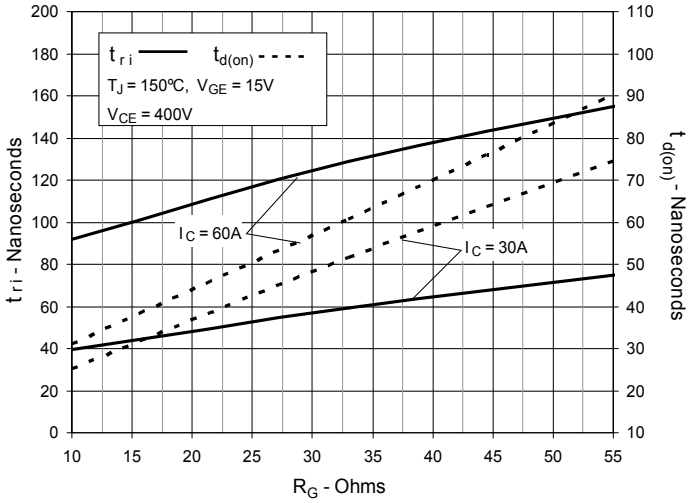

Fig. 20. Inductive Turn-on Switching Times vs. Collector Current

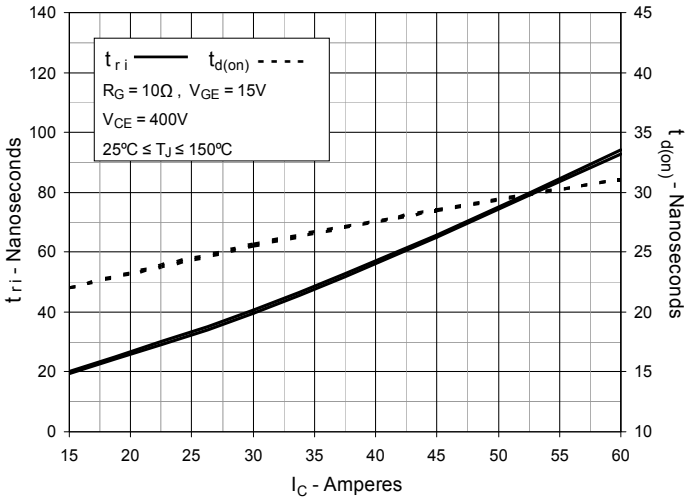

Fig. 21. Inductive Turn-on Switching Times vs. Junction Temperature

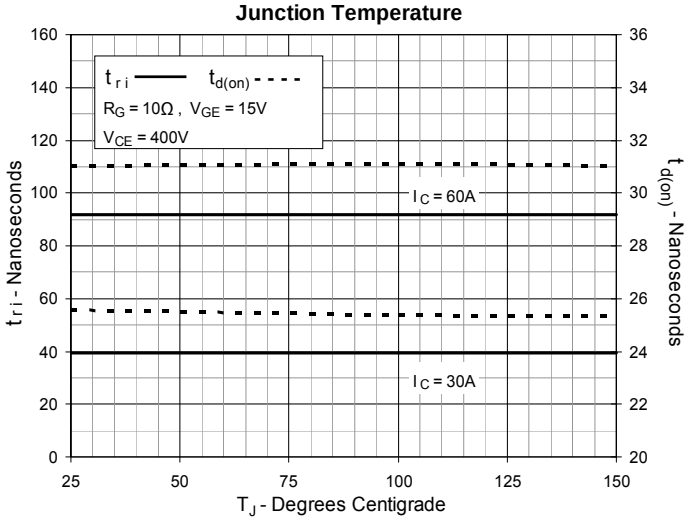

Fig. 22. Maximum Transient Thermal Impedance (Diode)

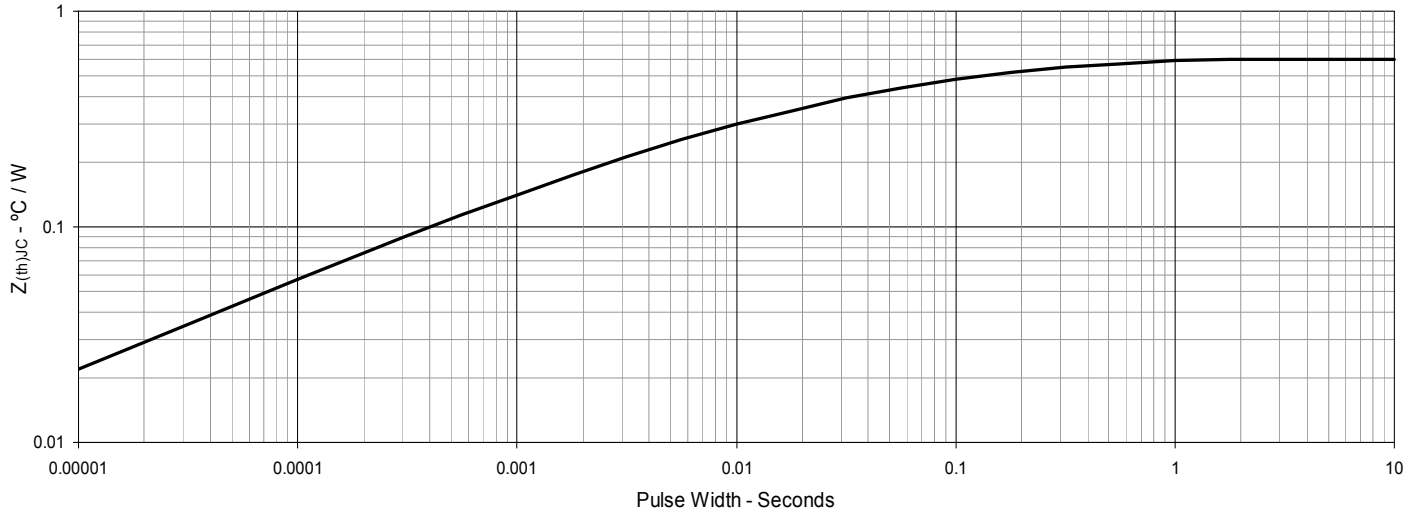

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Fig. 23. Forward Current vs. Forward Voltage

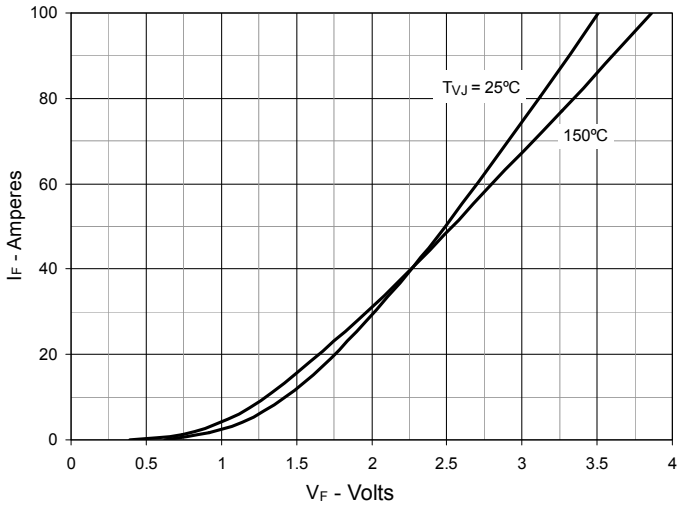


Fig. 24. Reverse Recovery Charge Q_{RR} vs. -di_F/dt

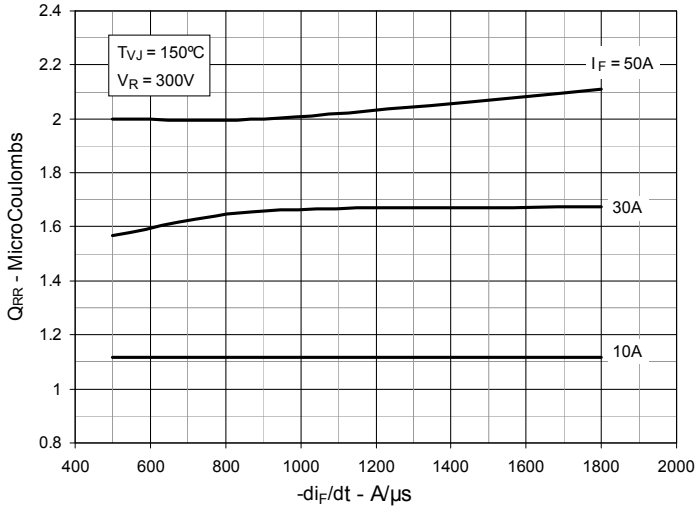


Fig. 25. Peak Reverse Current I_{RM} vs. -di_F/dt

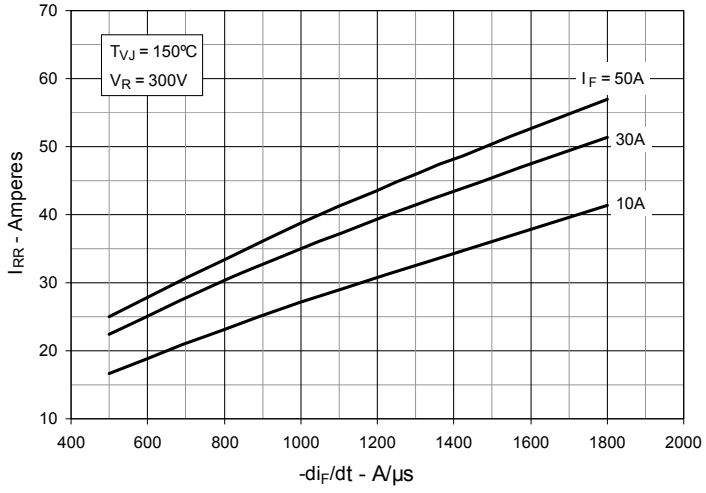


Fig. 26. Recover Time t_{RR} vs. -di_F/dt

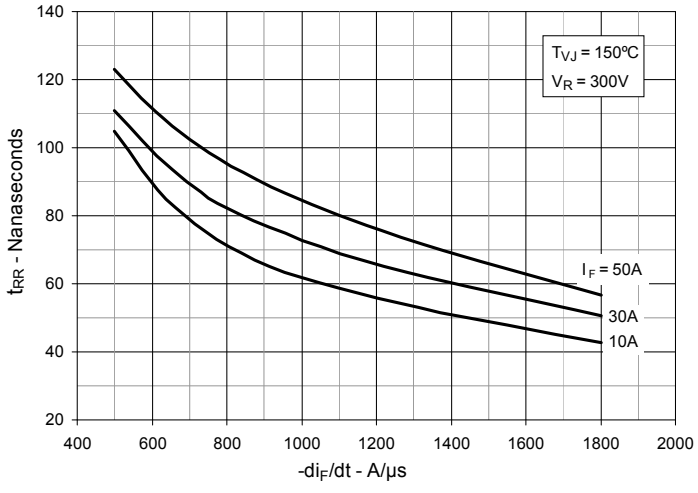


Fig. 27. Recovery Energy E_{REC} vs. -di_F/dt

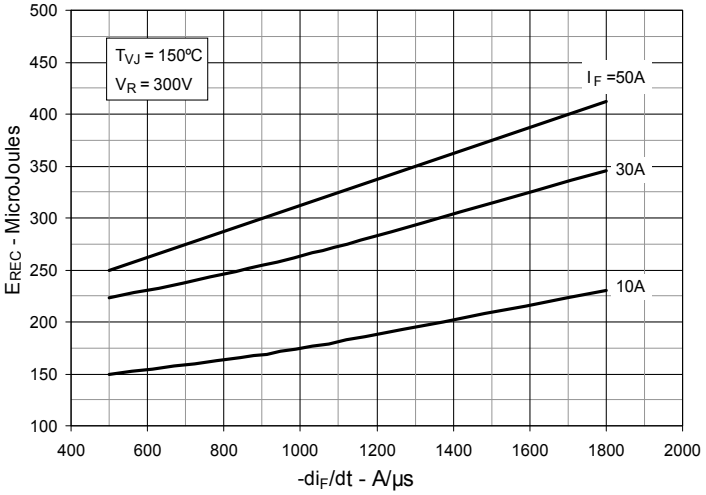
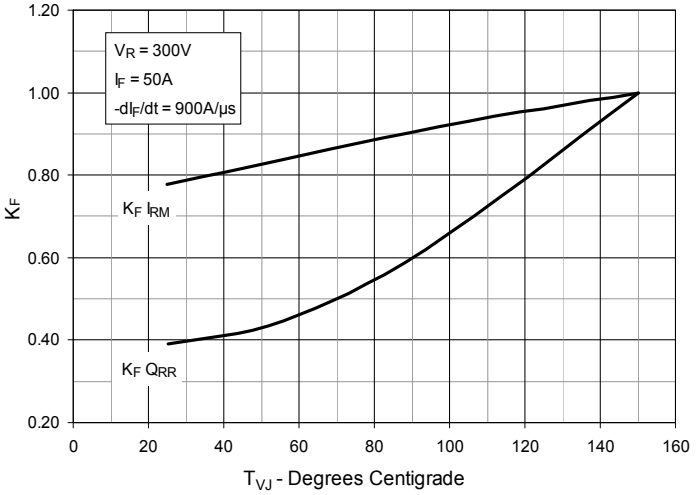


Fig. 28. Dynamic Parameters Q_{RR}, I_{RM} vs. Virtual Junction Temperature T_{VJ}



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